

## Part Number: XZVG53W-3

1.6 x 0.8 mm SMD Chip LED Lamp

## **Features**

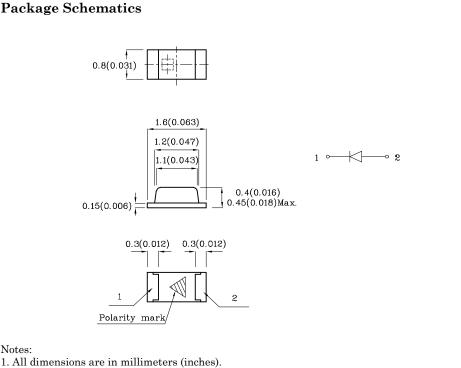
- Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 2,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- Halogen-free
- RoHS compliant





ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

Notes:



2.Tolerance is  $\pm 0.1(0.004")$  unless otherwise noted.

3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T <sub>A</sub> =25°C)		Green (AlGaInP)	Unit	
Reverse Voltage	$V_{\mathrm{R}}$	5	v	
Forward Current	$I_{\rm F}$	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	$i_{FS}$	150	mA	
Power Dissipation	$\mathbf{P}_{\mathrm{D}}$	75	mW	
Operating Temperature	TA	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85	U	

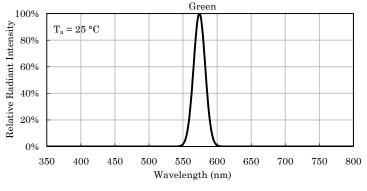
A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

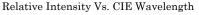
Operating Characteristics (T <sub>A</sub> =25°C)		Green (AlGaInP)	Unit	
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	2.1	V	
Forward Voltage (Max.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	2.5	V	
Reverse Current (Max.) (V <sub>R</sub> =5V)	$I_R$	10	μΑ	
Wavelength of Peak Emission CIE127-2007* (Typ.) (I <sub>F</sub> =20mA)	λP	574*	nm	
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I <sub>F</sub> =20mA)	λD	570*	nm	
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	$ riangle\lambda$	20	nm	
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	15	pF	

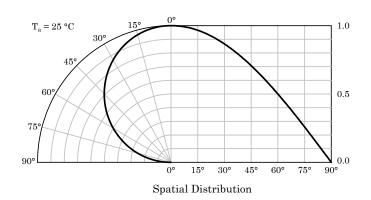
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous CIE127 (I <sub>F</sub> =20 m	7-2007* 0mA)	Wavelength CIE127-2007* nm λΡ	Viewing Angle 20 1/2
				min.	typ.		
XZVG53W-3	Green	AlGaInP	Water Clear	20*	49*	574*	120°

\*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

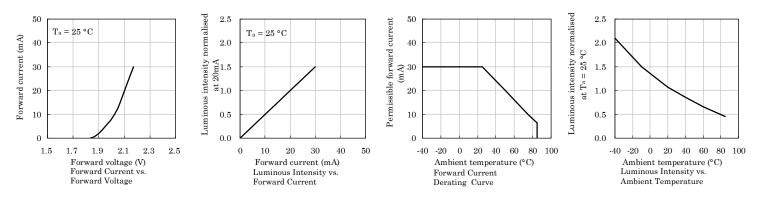




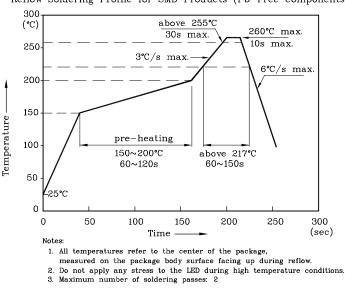




## ✤ Green



# LED is recommended for reflow soldering and soldering profile is shown below.

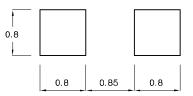


Reflow Soldering Profile for SMD Products (Pb-Free Components)

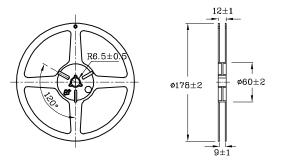


✤ The device has a single mounting surface. The device must be mounted according to the specifications.

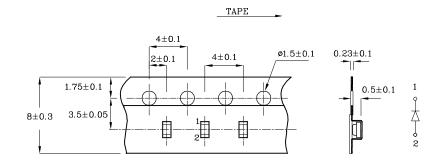
Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Reel Dimension (Units : mm)



## Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

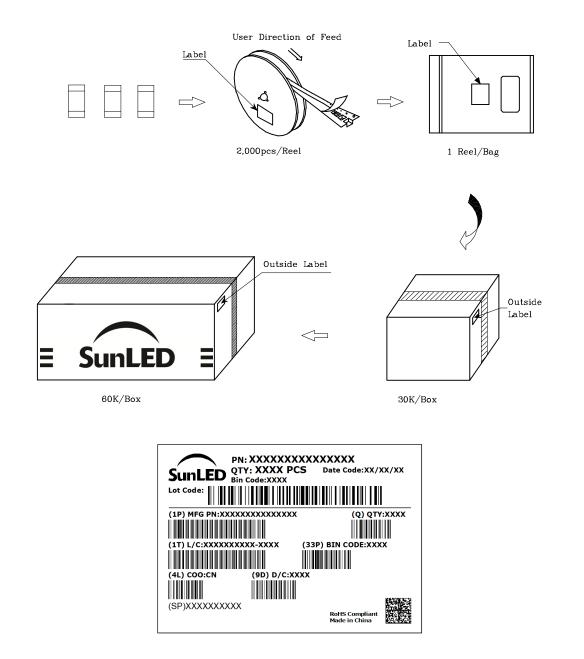
2. Luminous intensity / luminous flux: +/-15%

3. Forward Voltage: +/-0.1V  $\,$ 

Note: Accuracy may depend on the sorting parameters.



# **PACKING & LABEL SPECIFICATIONS**



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- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet.
- User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
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